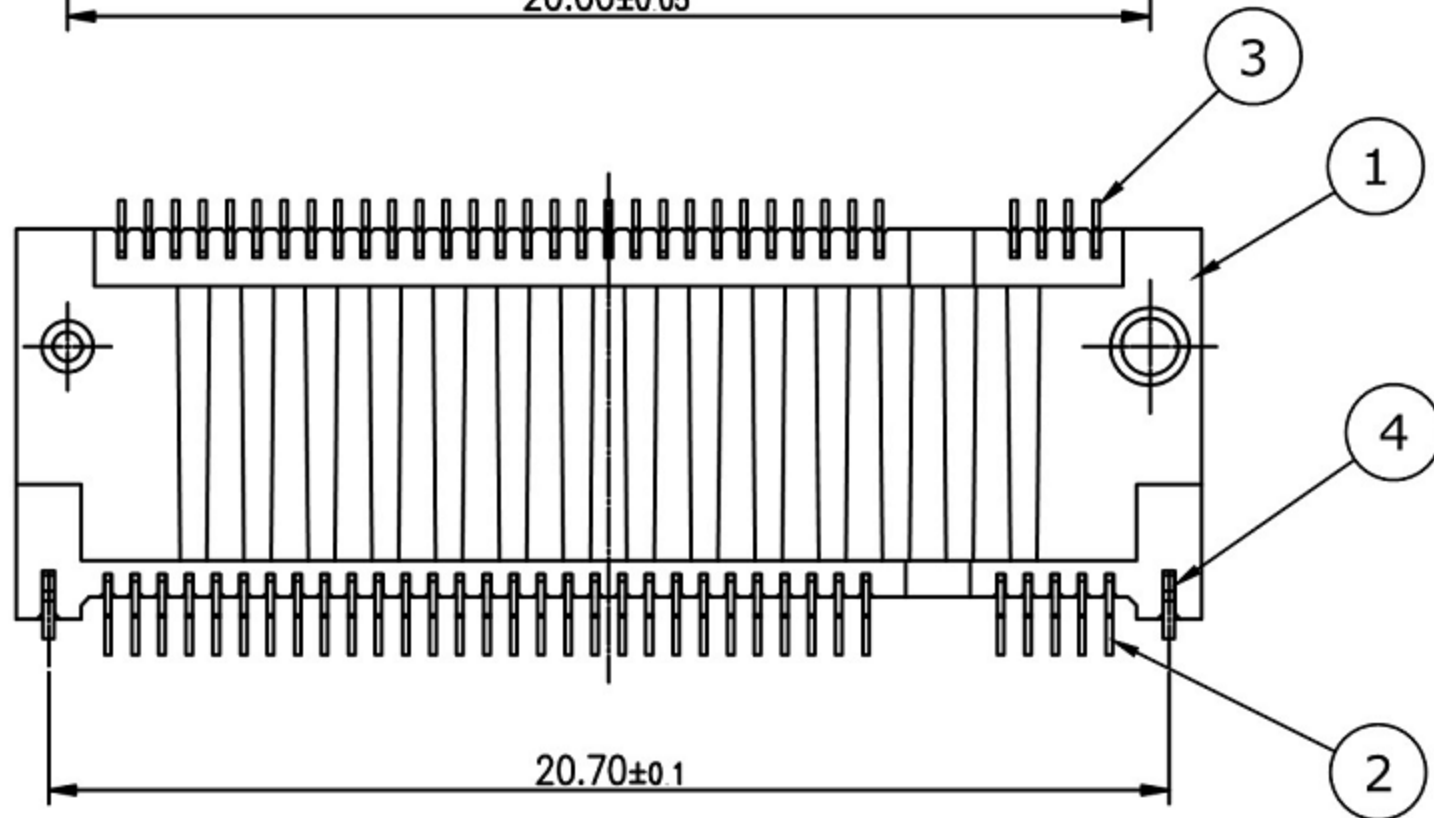
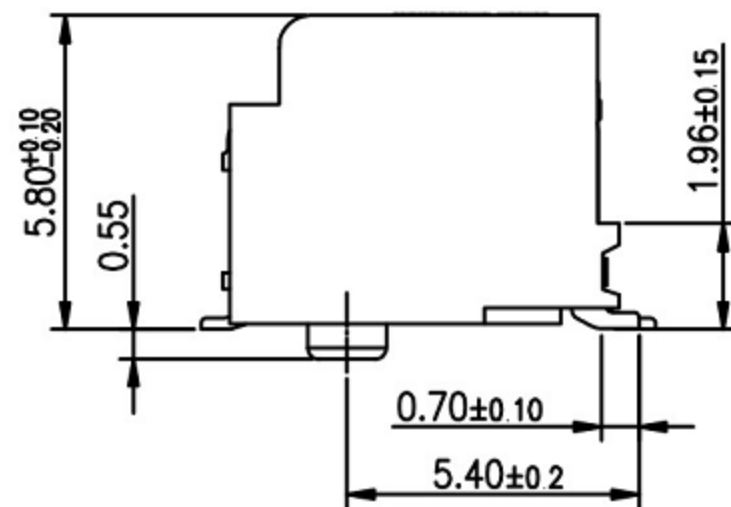
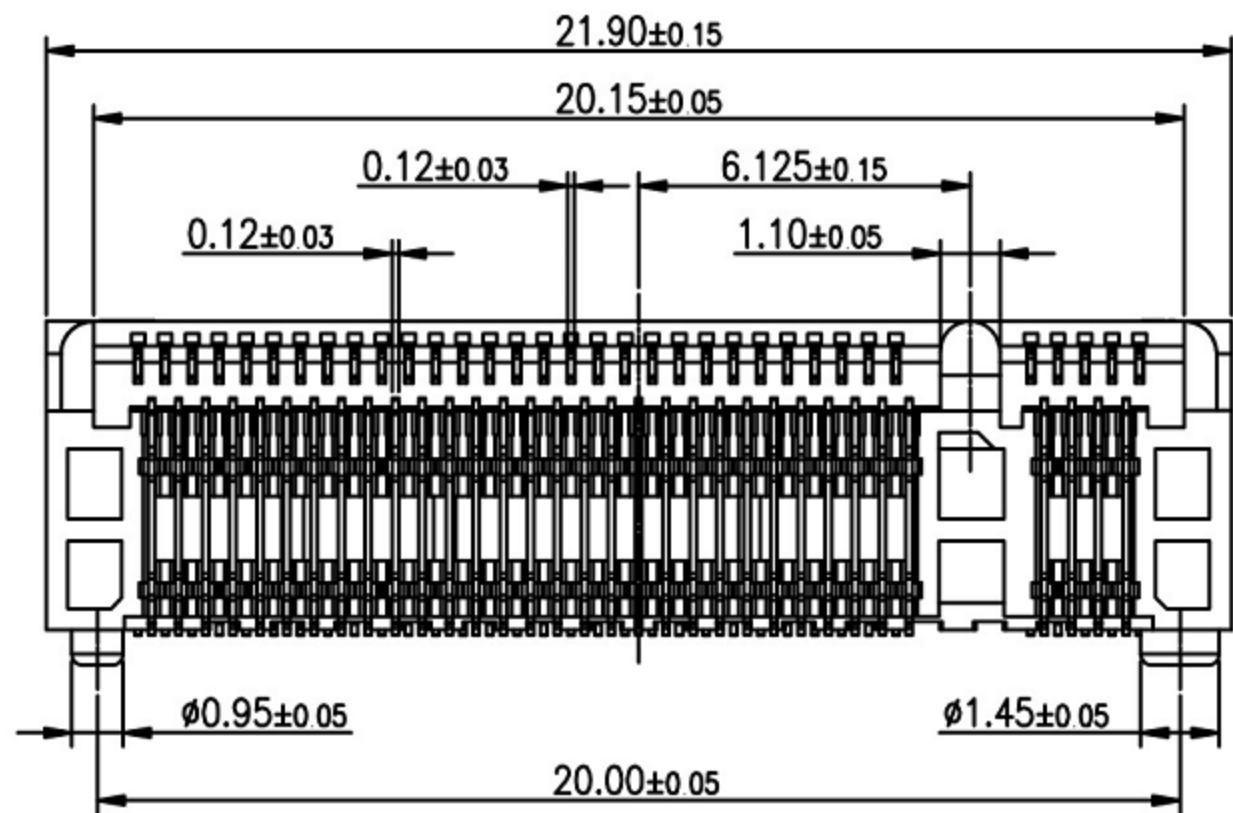
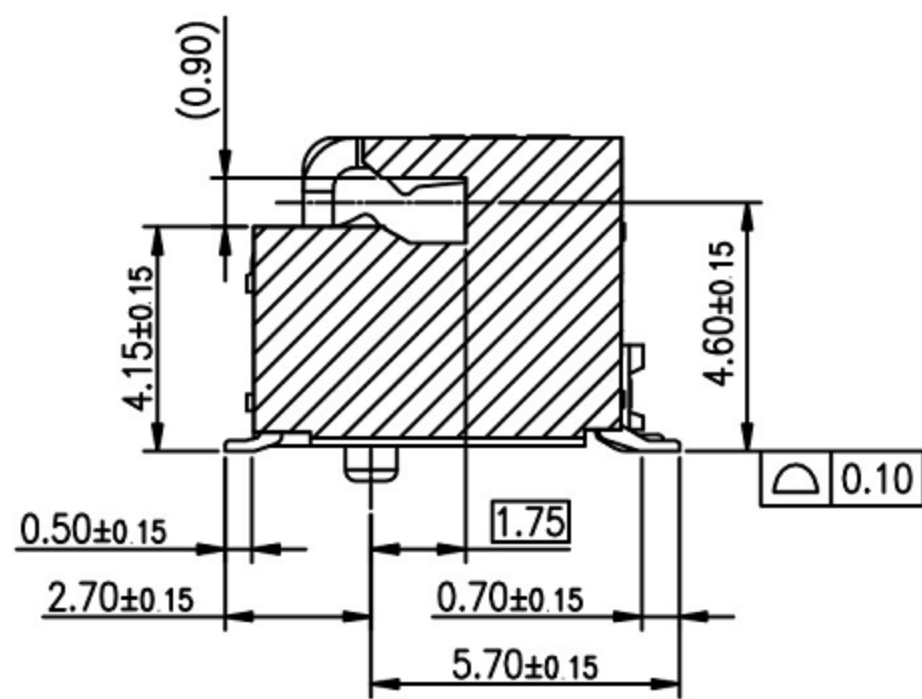
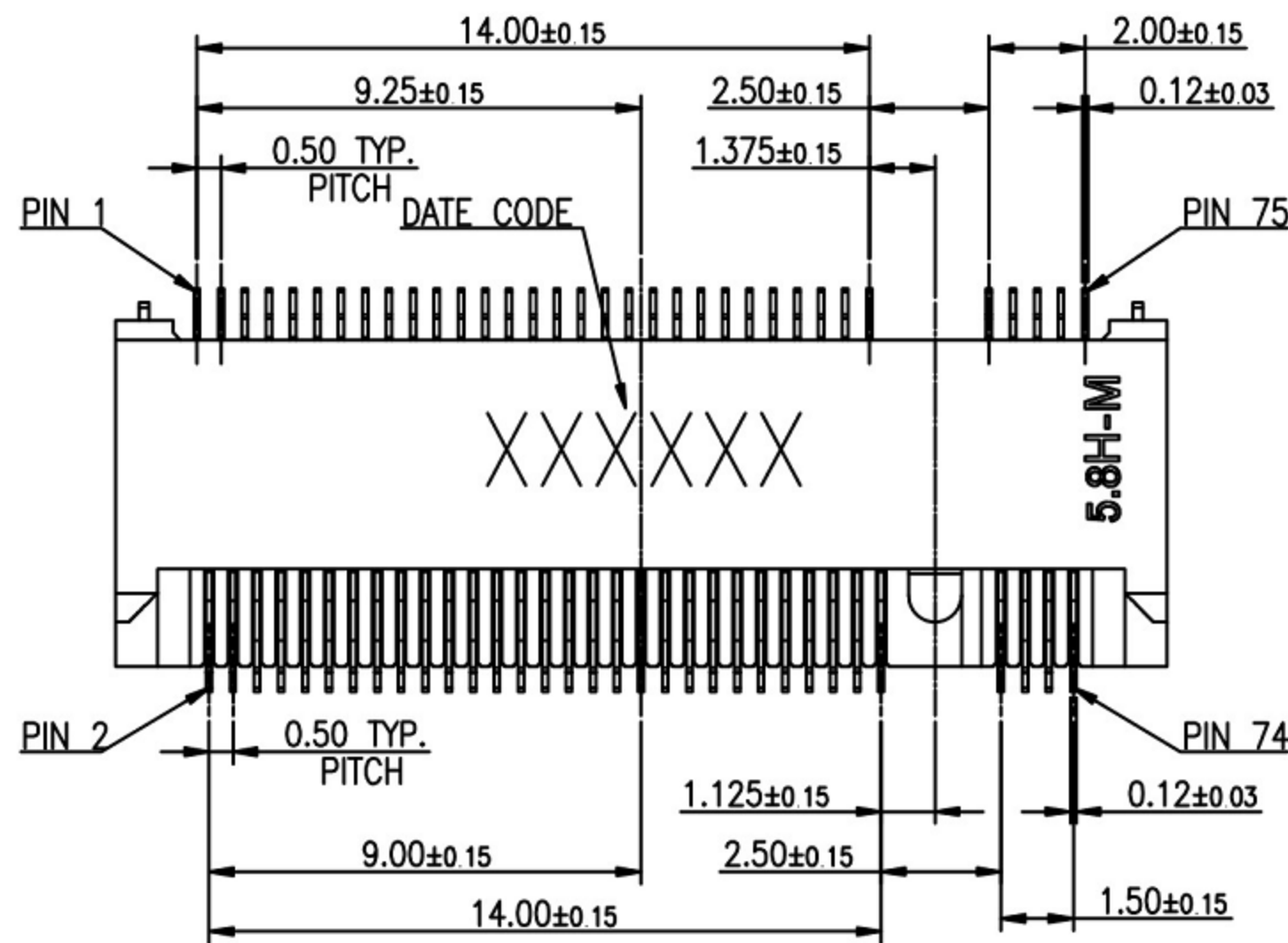


CAD FILE:

ROHS



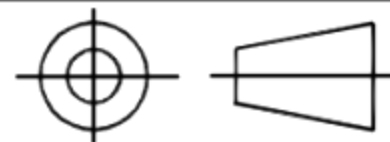
REV.	DESCRIPTION	DRAWN	DATE
1	INITIAL RELEASE	TIM	2021/06/08

SPECIFICATION:

- ELECTRICAL
 - Current Rating: 0.5A per pin
 - Voltage Rating: 50VAC
 - Contact Resistance: 55mΩ, Δ20mΩ MAX.
 - Insulation Resistance: 500MΩ
 - Dielectric Withstanding Voltage: 300VAC
- MECHANICAL
 - Durability: 60 Cycle
 - Mating Force: 20N max.
 - Un-mating Force: 20N max.
- ENVIRONMENTAL
 - Operating temperature range: -40°C~+85°C
 - Storage temperature range: -40°C~+85°C
- SOLDER ABILITY
 - Recommended IR-Reflow Temperature: 260°C

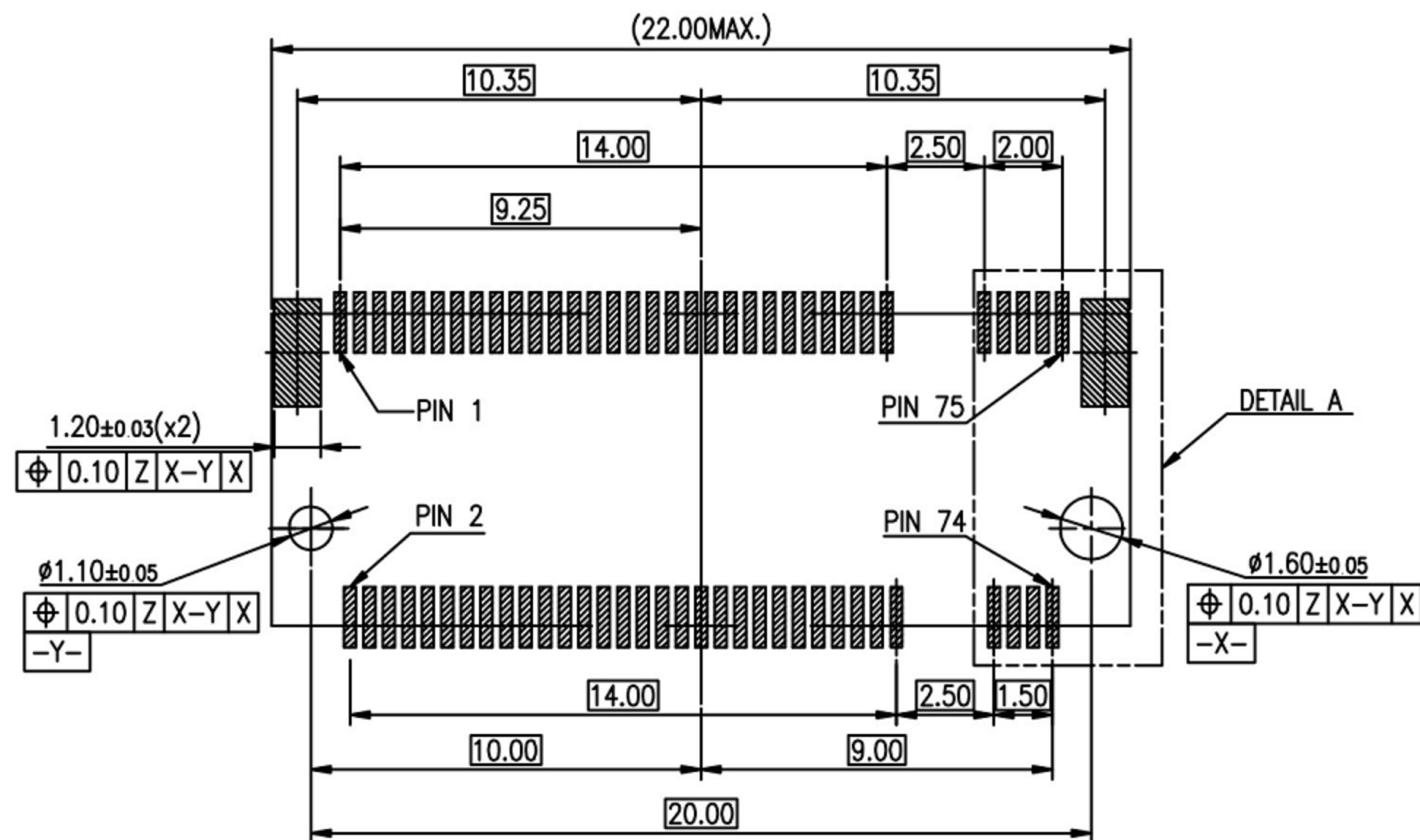
4	HOLD DOWN	Copper alloy, 50u" min. Matte Tin plated, under-plated Nickel 50u" min.
3	LOWER CONTACT	Copper alloy,
2	UPPER CONTACT	Contact area: Gold flash, Solder area: Gold flash, all under-plated Nickel 50u" min.
1	INSULATOR	Thermoplastic, UL94V-0, Black
NO.	PART NAME	DESCRIPTION

8					TOLERANCE				
7					UNLESS SPECIFIED				
6					WITHIN 1.5mm : ±0.1mm	A	2012-9-25	初 版	ZENQ. CHEN
5					OVER 1.5mm : ±0.2mm	ISSUE	DATE	DESCRIPTIONS OF REVISION	APPD.
4	CONTACT	SUS	1	Ag CLAD	TITLE : PCB卡插座			UNIT : mm	DRWG NO.: XB-123A-58M01_B_1
3	CASE	PPA/BRASS SRTIP	1	BLACK/Ag PLATED	MODEL: PCB Card Socket			SCALE: 5:1	DWN. JUN. YANG 2012-9-25
2	COVER	STEEL STRIP	1	Ni PLATED	 东莞市溪榜电子有限公司 DONG GUAN XI BANG ELECTRONI CS CO., LTD.			CHK'D	DONG. PANG 2012-9-25
1	KNOB	PPA	1	BLACK				APPD.	ZENQ. CHEN 2012-9-25
NO.	PARTS	MATERIALS	Q'TY	FINISH					

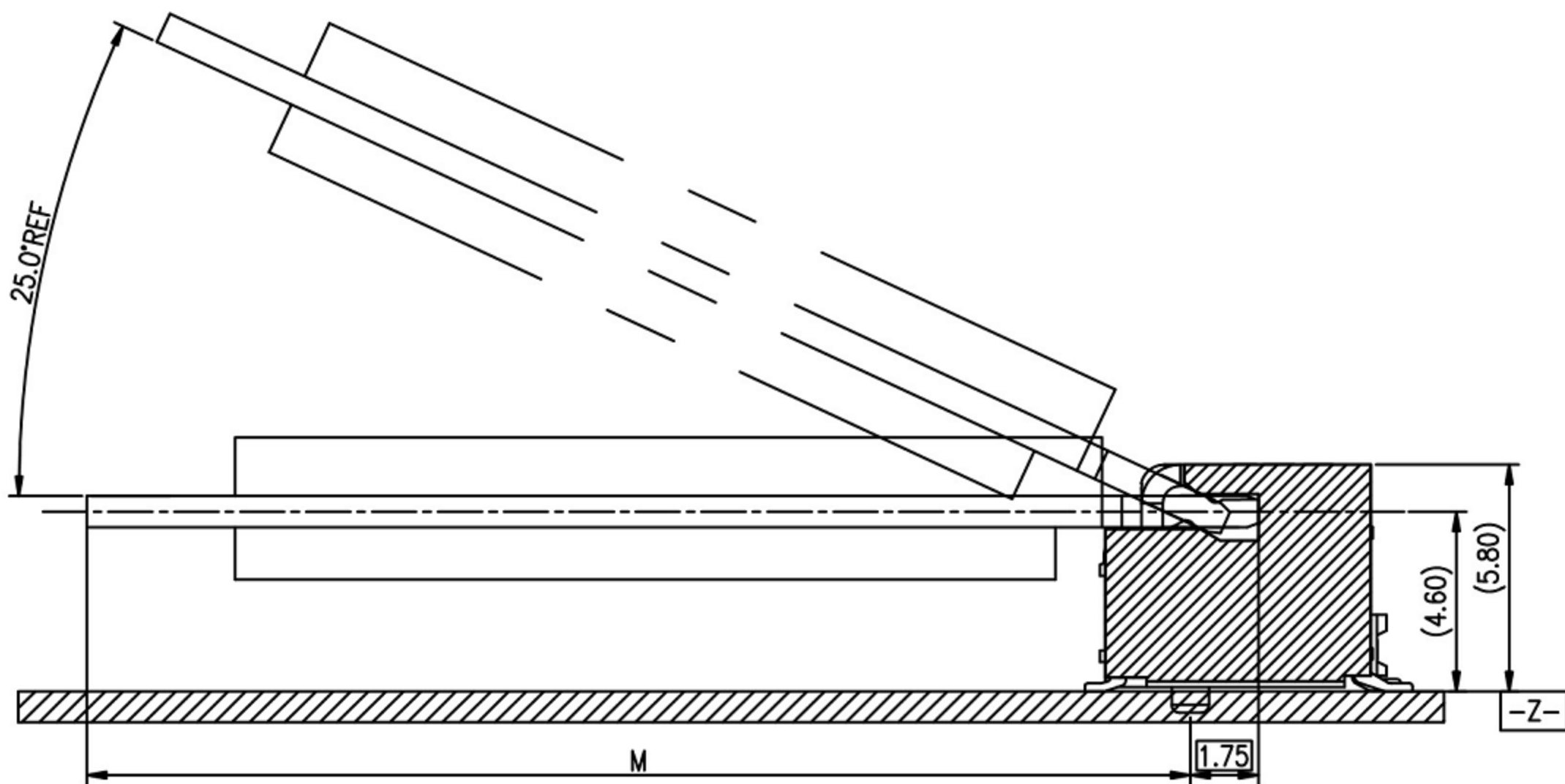
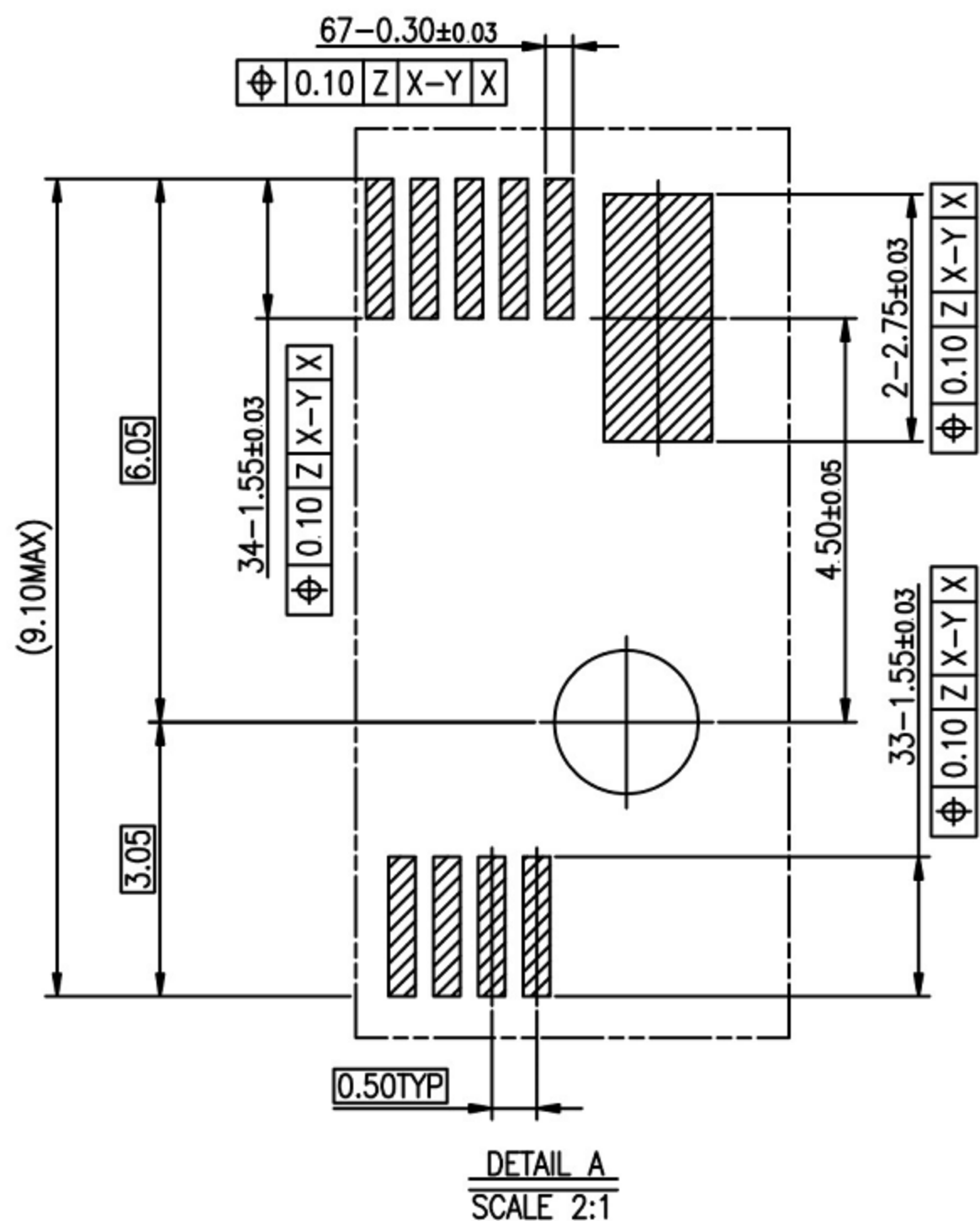


CAD FILE:

ROHS



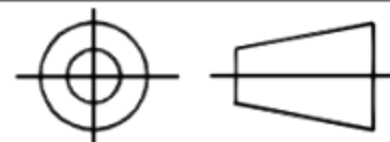
RECOMMEND PCB LAYOUT(TOP VIEW)
(DEFAULT TOLERANCE:±0.05mm)



108.25
78.25
58.25
40.25
28.25
DIM. M

REV.	DESCRIPTION	DRAWN	DATE
	see sheet one		

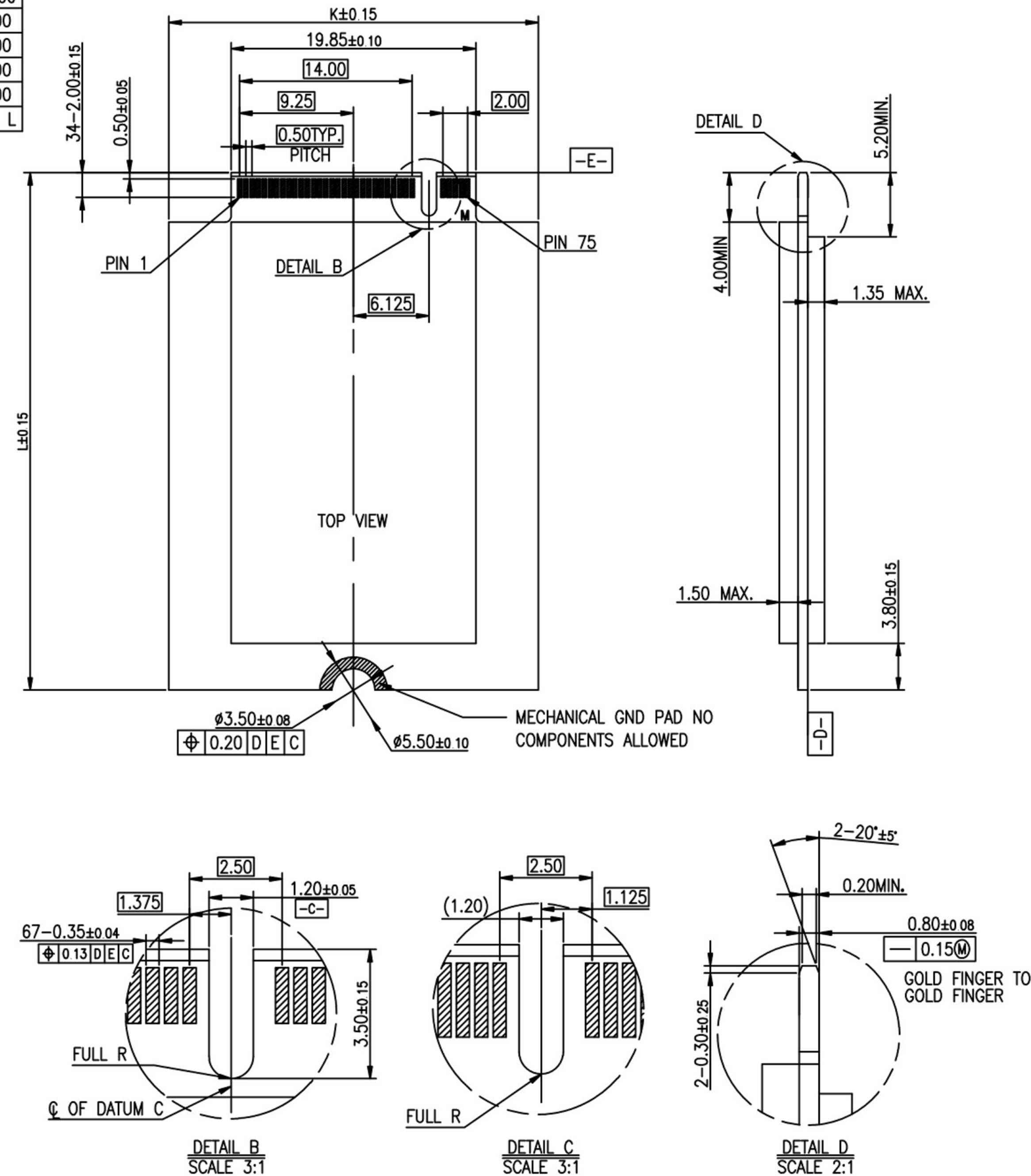
8					TOLERANCE				
7					UNLESS SPECIFIED				
6					WITHIN 1.5mm : ±0.1mm	A	2012-9-25	初 版	ZENQ. CHEN
5					OVER 1.5mm : ±0.2mm	ISSUE	DATE	DESCRIPTIONS OF REVISION	APPD.
4	CONTACT	SUS	1	Ag CLAD	TITLE : PCB卡插座			UNIT : mm	DRWG NO.: XB-123A-58M01_B_1
3	CASE	PPA/BRASS SRTIP	1	BLACK/Ag PLATED	MODEL: PCB Card Socket			SCALE: 5:1	DWN. JUN. YANG 2012-9-25
2	COVER	STEEL STRIP	1	Ni PLATED	 东莞市溪榜电子有限公司 DONG GUAN XI BANG ELECTRONICS CO., LTD.			CHK'D DONG. PANG 2012-9-25	
1	KNOB	PPA	1	BLACK				APPD. ZENQ. CHEN 2012-9-25	
NO.	PARTS	MATERIALS	Q'TY	FINISH					



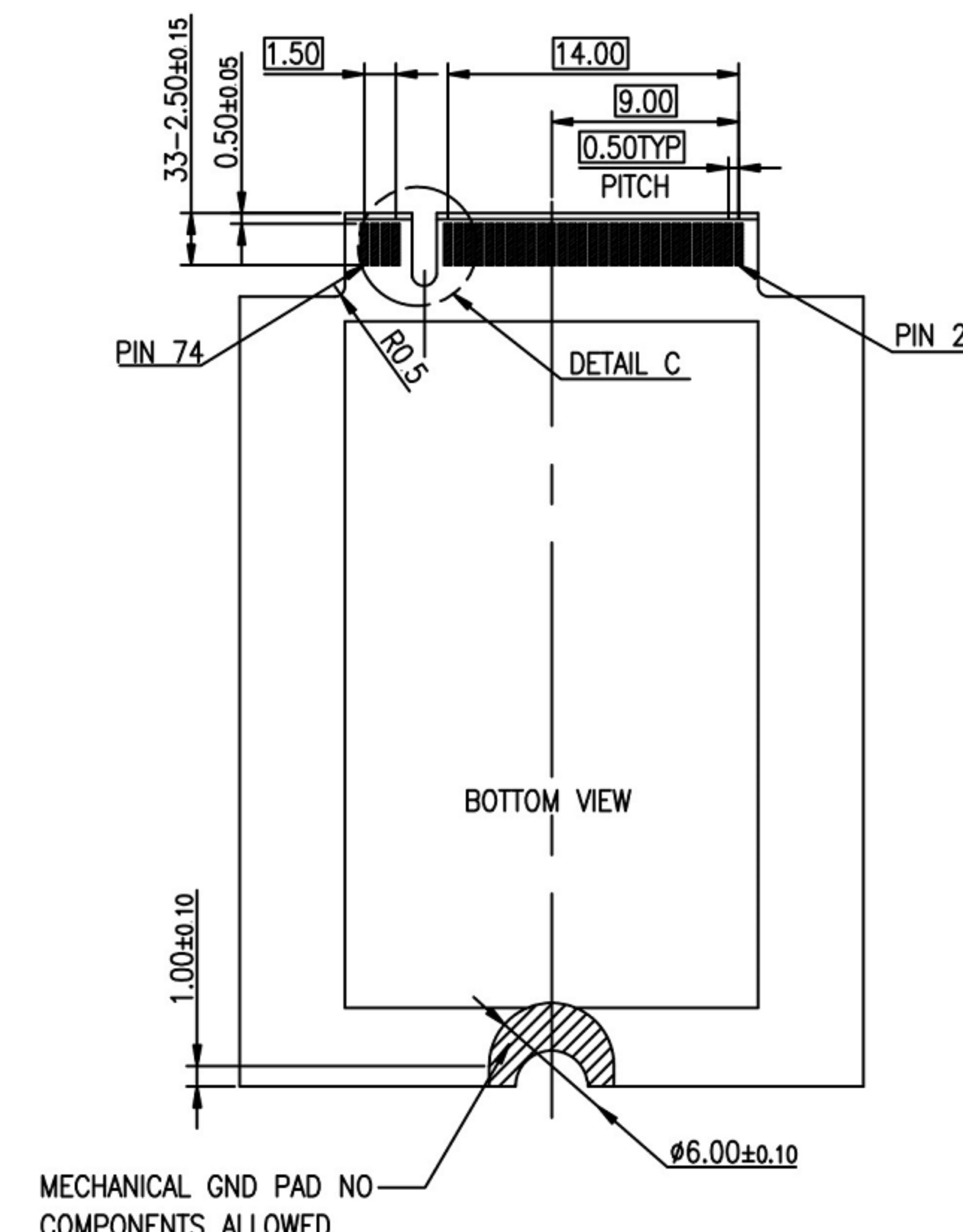
CAD FILE:

ROHS

30.00	110.00
22.00	80.00
	60.00
	42.00
	30.00
DIM. K	DIM. L



REV.	DESCRIPTION	DRAWN	DATE
	see sheet one		



8					TOLERANCE				
7					UNLESS SPECIFIED				
6					WITHIN 1.5mm : ±0.1mm	A	2012-9-25	初版	ZENQ. CHEN
5					OVER 1.5mm : ±0.2mm	ISSUE	DATE	DESCRIPTIONS OF REVISION	APPD.
4	CONTACT	SUS	1	Ag CLAD	TITLE : PCB卡插座			UNIT : mm	DRWG NO.: XB-123A-58M01_B_1
3	CASE	PPA/BRASS SRTIP	1	BLACK/Ag PLATED	MODEL: PCB Card Socket			SCALE: 5:1	DWN. JUN. YANG 2012-9-25
2	COVER	STEEL STRIP	1	Ni PLATED	 东莞市溪榜电子有限公司 DONG GUAN XI BANG ELECTRONICS CO., LTD.			CHK'D	DONG. PANG 2012-9-25
1	KNOB	PPA	1	BLACK				APPD.	ZENQ. CHEN 2012-9-25
NO.	PARTS	MATERIALS	Q'TY	FINISH					